

# User Manual OPS Computer

Open Pluggable Specification Computer



#### **Overview**

#### **Icon Descriptions**

The icons are used in the manual to serve as an indication of interest topics or important messages. Below is a description of these icons:



**NOTE:** This mark indicates that there is a note of interest and is something that you should pay special attention on while using the product



**WARNING:** This mark indicates that there is a caution or warning and it is something that could damage your property or product

#### **Copyright and Trademarks**

This document is copyrighted, © 2014 All rights are reserved. The original manufacturer reserves the right to make improvements to the products described in this manual at any time without notice.

No part of this manual may be reproduced, copied, translated or transmitted in any form or by any means without the prior written permission of the original manufacturer. Information provided in this manual is intended to be accurate and reliable. However, the original manufacturer assumes no responsibility for its use, nor for any infringements upon the rights of third parties that may result from such use.

#### Acknowledgement

Intel, Pentium and Celeron are registered trademarks of Intel Corp.

Microsoft Windows and MS-DOS are registered trademarks of Microsoft Corp.

All other product names or trademarks are properties of their respective owners.

#### **Compliances and Certification**

#### **CE Certification**

This product has passed the CE test for environmental specifications. Test conditions for passing included the equipment being operated within an industrial enclosure. In order to protect the product from being damaged by ESD (Electrostatic Discharge) and EMI leakage, we strongly recommend the use of CE-compliant industrial enclosure products.

#### **FCC Class A Certification**

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

### **Contents**

Chapter 1: Introduction	2
System SpecificationPackage Contents	
Chapter 2: System Components	6
System Drawing	
Front ConnectorsRear Connectors	
Chapter 3: Board Connector	9
Connectors and Jumpers List	
Chapter 4: Hardware Setup	12
Preparing the Hardware Installation	12
System Memory3G and Wireless Module Installation	
3G SIM Card Installation	
Installing the Hard Disk	
Appendix A: Terms and Conditions	14
Warranty Policy	
RMA Service	14

### Chapter 1.

### Chapter 1: Introduction

Thank you for choosing the AOPS-7080. The AOPS-7080 is an Open Pluggable Specification (OPS) for IWB and digital signage application. The AOPS-7080 addresses IWB and digital signage market fragmentation and simplify device installation, usage, maintenance, and upgrades.

This OPS provides a rich I/O capabilities via highbandwidth interfaces such as PCI Express 2.0, Serial ATA 3.0, and Hi- Speed USB 3.0 connectivity.

Other I/O capabilities include an HDMI port, a MIC-In and Line Out as well as an Intel® i210 Gigabit Ethernet.



#### Warning:

While using the OPS, do not disconnect the power source. It will be Cause fatal failure

#### **System Specification**

System Specification			
	System		
CPU	Intel® Core $^{\text{TM}}$ i5-4400E Processor ( 3M Cache, up to 3.30 GHz)		
BIOS	AMI SPI BIOS		
System chipset	Intel® QM87 Express Chipset		
System Memory	DDR3L-1333, 4GB (2GB x 2)		
	I/O		
Storage	2.5" SDD 128GB		
USB	2x USB 3.0 Type A in front panel 3x USB 2.0 and 1x USB 3.0 through JAE TX25 80- pin connector		
Mini- PCIe	1x mini-PCIexpress socket for mini-card module		
	Display		
Chipset	Intel® integrated HD 4600		
Display Supported	HDMI: Display port and TMDS through JAE TX25 80-pin connector		
	Audio Interface		
Chipset	Realtek ALC886		
Interface	Mic-in, Line-out : Audio L/R through JAE TX25 80-pin connector		
	Ethernet		
LAN Chip	Intel® i210 Gigabit Ethernet		
Ethernet	1x10/ 100/ 1000 Base-Tx Gigabit Ethernet		
N	Mechanical & Environmental		
Power Requirement	DC 12V, 5A		
Operating Temperature	-5°C to +45°C (32 ~ 140°F)		
Storage Temperature	-20°C to +75°C (-4 ~ 158°F)		
Size (L x W x H)	119mm(D) x 200mm(W) x 30mm(H) (4.69" x 7.87" x 1.18")		
Certification	CE / FCC / KCC		

### Chapter 1.

#### **Package Contents**

 $\cdot$  If any items are missing, contact your dealer.

Your package contains the following items:

- AOPS-7080 OPS System (installed Set)
- Drivers and User's Manual CD
- Adaptor DC12V, 5A

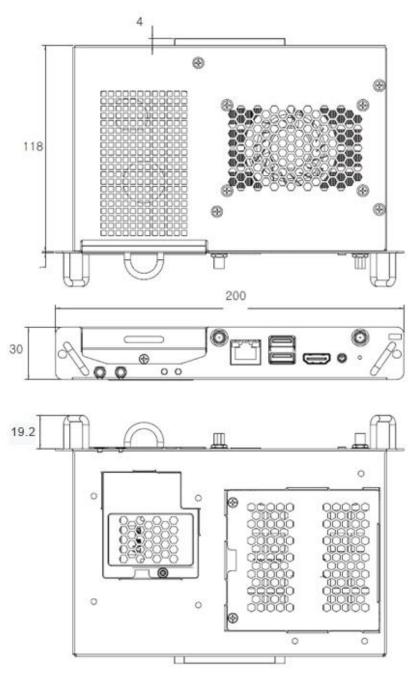
### Chapter 2.

### Chapter 2: System Components

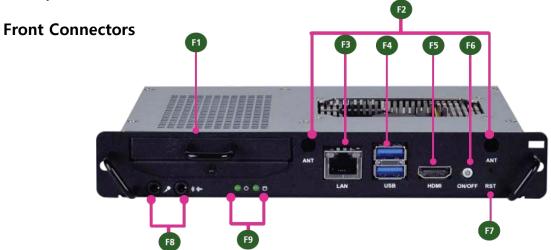
#### **System Drawing**

Mechanical dimensions of the AOPS-7080.

Unit: mm



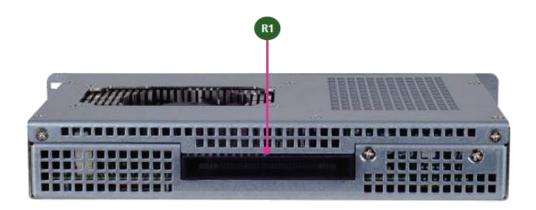
### Chapter 2.



Component Description		Pin Definition Reference
F1 Hard Disk Slot	External 2.5" hard drive bay for easy access	
	and replacement of the data storage. It sup-	
	ports SATA 3.0 specification	
F2 Antenna Hole	Reserved hole for 3G/Wi-Fi module antenna	
F3 Gigabit Ethernet LAN por	t The LAN port is provided by Intel i210 Ethernet controller which supports10/100/1000Mbps connection speeds and PXE (Preboot eXecution Environment). The LAN port LED indicator is described below:	
	LINK/ACT (Amber)	
SPEED LINK/ACT	<ul> <li>On/Flashing: The port is linking and active in data transmission.</li> </ul>	
	<ul> <li>Off: The port is not linking.</li> </ul>	
	SPEED (Green/Yellow)	
	<ul> <li>Yellow: The connection speed is 1000Mbps.</li> </ul>	
	Green: The connection speed is 100Mbps	
	<ul> <li>Off: .The connection speed is 10Mbps.</li> </ul>	
F4 USB 3.0 type A ports	Two USB 3.0 type A ports	USB1 on page 11
R5 HDMI Port (*)	An HDMI port (single link) which is provided by Intel integrated HD 4600	HDMI1 on page 10
F6 Power-on Button with Dual LED	ATX power-on button with LEDs: stand-by mode in red; power-on mode in green.	
F7 Reset Button	A hardware reset button	
F8 Mic-in Port/Line-out	Connect audio devices to these port.	MIC1/LINE1 on page 10
F9 HDD (Green) and	HDD	
	Blinking: data access activities	
Power LED (Green)		
	<ul> <li>Off: no data access activities</li> </ul>	
	Power	
	<ul> <li>On: The computer is on.</li> </ul>	
	Off: The computer is off .	

### Chapter 2.

#### **Rear Connectors**



Component	Description	Pin Definition Reference
R1 TX-25 80-pin connector	This connects to the docking board-LEK-IOB2	OPS1 on page 10

#### **Connectors and Jumpers List**

### Chapter 3.

Chapter 3:	
<b>Board connector</b>	

#### **Connectors and Jumpers List**

The tables below list the function of each of the board connectors by labels shown in the above section. The next section in this chapter gives pin definitions.

Label	Function	Pin Definition Ref. Page
OPS Connector	JAE TX-25 80-pin Connectors	Page 10
Line 1	Line-out Phone Jack	Page 10
MIC 1	MIC-in Phone Jack	Page 10
HDMI 1	HDMI Connector	Page 10
LAN 1	LAN Port	Page 11
USB 1	Dual Stack USB type A Connector	Page 11
MPCIE 1	Mini-PCIe Connector	Page 11
CMOS 1	Clear CMOS Jumper (Inside of set)	Page 11

### Chapter 3.

#### **OPS Connector (OPS1)**

Signal	PIN	Signal
DDP 3N	41	RSVD
DDP 3P	42	RSVD
	43	RSVD
	44	RSVD
	45	RSVD
GND	46	RSVD
DDP 1N	47	RSVD
	48	RSVD
GND	49	RSVD(DDP
(2000)	1,306,03	AUX EN)
DDP ON	50	SYS FAN EN
		UART RX
		UART_TX
		GND
	0.0	Stda SSRX-
		Stda_SSRX+
327000000000000000000000000000000000000		GND
	70	Stda_SSTX-
		Stda_SSTX+
		GND
	20 - 100-	USB PN2
		USB PP2
	20100000	GND
	200 CONTRACT	USB PN1
	70	USB PP1
	65	GND
	66	USB PN0
	-	USB PP0
	100000	GND
	200	AZ_LINEOUT_L
S 20 12/19		,
	70	AZ LINEOUT R
	1.00	/\LL\LOOT_IX
	71	CEC
	-	PB DET
		PS ON#
DC IN		PWR STATUS
DC IN		GND
		GND
		GND
DC IN		GND
		GND
DC IN	80	GND
	DDP_3P GND DDP_2N DDP_2P GND DDP_1N DDP_1P GND  DDP_0N DDP_0P GND DDP_AUXN DDP_AUXP DDP_HPLUG GND TMDS_CLKN TMDS_CLKP GND TMDSON TMDS1N TMDS1P GND TMDS2P GND TMDS2P GND TMDS_DC_ DATA TMDS_DCC_ CLK TMDS_DCC_ CLK TMDS_HPLUG GND TMDS_DCC_ CLK	DDP_3N         41           DDP_3P         42           GND         43           DDP_2N         44           DDP_2P         45           GND         46           DDP_1N         47           DDP_1P         48           GND         50           DDP_OP         51           GND         52           DDP_AUXN         53           DDP_AUXP         54           DDP_HPLUG         55           GND         59           TMDS CLKN         57           TMDS CLKP         58           GND         59           TMDSON         60           TMDSOP         61           GND         62           TMDS1N         63           TMDS2N         66           TMDS2N         66           TMDS2P         67           GND         68           TMDS_DDC_         69           DATA         71           GND         72           DC_IN         73           DC_IN         73           DC_IN         75           DC_IN

#### Line-out Jack (Line 1)

PIN	Signal	
1	LINE_OUT_R	
2	N.C	
3	LINE_OUT_L	
4	EARPHONE DET	
5	GND	
6	GND	

#### Microphone Jack (MIC1)

PIN	Signal	
1	MIC R	
2	N.C	
3	MIC_L	
4	MIC DET	
5	GND	
6	GND	

#### **High-Definition Multimedia Interface (HDMI1)**



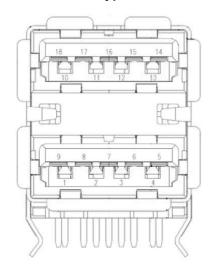
PIN NO.	Signal	PIN NO.	Signal
1	DATA2+	2	GND
3	DATA2-	4	DATA1+
5	GND	6	DATA1-
7	DATA0+	8	GND
9	DATA0-	10	CLK+
11	GND	12	CLK-
13	N.C	14	N.C
15	DDC CLK	16	DDC DAT
17	GND	18	HDMI_VCC
19	HPD		

### Chapter 3.

#### Gigabit Ethernet (LAN1)

Pin No.	Signal		
	Fast Ethernet	Gigabit Ethernet	
1	TX+	MD0+	
2	TX-	MD0	
	RX+	MD1+	
4	T45	MD2+	
5	T45	MD2-	
6	RX-	MD1-	
7	T78	MD3+	
8	T78	MD3-	
9	10-/100-/1000+		
10	10+/100+/1000-		
11	Link+/ACT-		
12	Link-/ACT+		

#### Dual Stack USB 3.0 Type A Connector (USB1)



PIN NO.	Signal	PIN NO.	Signal
1	USB_VCC1	10	USB VCC2
2	USB1 D-	11	USB2_D-
3	USB1_D+	12	USB2_D+
4	GND	13	GND
2 3 4 5 6	USB1_RX-	14	USB2_RX-
6	USB1_RX+	15	USB2 RX+
7	GND	16	GND
8 9	USB1 TX-	17	USB2 TX-
9	USB1_TX+	18	USB2_TX+

#### Mini PCI-Express with SIM Card Reader(MPCIE1)

PIN NO.	Signal	PIN NO.	Signal			
1	WAKE#	2	+3.3V			
3	RSVD	4	GND			
5	RSVD	6	+1.5V			
	GND	13	GND			
7	CLKREQ#	8	UIM_PWR			
9	GND	10	UIM DATA			
11	REFCLK-	12	UIM CLK			
13	REFCLK+	14	UIM RESET			
15	GND	16	UIM VPP			
Key						
17	RSVD	18	GND			
19	RSVD	20	W DISABLE#			
21	GND	22	PERST#			
23	PERn0	24	+3.3V			
25	PERp0	26	GND			
27	GND	28	+1.5V			
29	GND	30	SMB_CLK			
31	PETn0	32	SMB DATA			
33	PETp0	34	GND			
35	GND	36	USB_D+			
37	GND	38	USB D-			
39	+3.3V	40	GND			
41	+3.3V	42	LED_WWAN#			
43	GND	44	LED_WLAN#			
45	RSVD	46	LED WPAN#			
47	RSVD	48	+1.5V			
49	RSVD	50	GND			
51	RSVD	52	+3.3V			

#### **Clear CMOS Jumper (CMOS1)**



PIN No.	Signal	
1-2	Normal (Default)	
2-3	Clear CMOS	

### Chapter 4.

### Chapter 4: Hardware Setup

#### **Preparing the Hardware Installation**

To access some components and perform certain service procedures, you must perform the following procedures first.



**WARNING:** To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. Portions of the power supply and some internal circuitry remain active until power is removed.

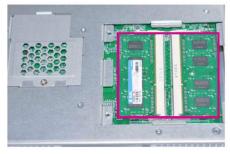
- 1. Unpowered the AOPS-7080 and make sure that the power source is removed.
- 2. It is not required to remove the system's top cover for installing most parts of the system such as the memory, 3G wireless module, SIM card, and the hard disk.

#### **Installing the System Memory**

The motherboard supports DDR3L memory that features data transfer rates of 1333 MHz to meet the higher bandwidth requirements of the latest operating system and Internet applications. It comes with one Double Data Rate 3 Low Voltage (DDR3L) Small Outline Dual Inline Memory Module (SO-DIMM) socket.

- Put the device upside down.
- 2. Take off the cover of the memory compartment by unscrewing two screws from its cover.
- 3. Align the memory module's key with the SO-DIMM socket's key.
- 4. Install the SO-DIMM.
- 5. Install the cover back to the system.







#### Note:

1. SO-DIMMs installed should meet the required speed which is DDR3L 1333 MHz. Do not install SO-DIMM supporting different speeds. 2. The motherboards can support up to 16 GB memory capacity in maximum.

### Chapter 4.

#### **3G and Wireless Module Installation(Optional)**

- 1. Take out the Mini-PCIe and SIM card compartment's cover by unscrewing the screws on the cover.
- 2. Align the wireless module's cutout with the Mini-PCIe slot notch.
- 3. Insert the wireless module into the connector diagonally.
- 4. Push the other end of the wireless module and secure it in place with the screws.
- 5. Install the Antenna to the module.

#### **3G SIM Card Installation(Optional)**

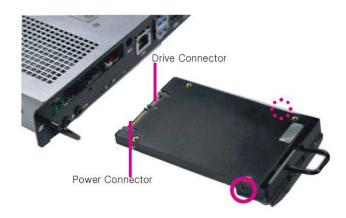
- 1. Take out the Mini-PCIe and SIM compartment's cover by unscrewing the screws on the cover.
- 2. Unlock the SIM card tray by sliding it outward and open it.
- 3. Place the SIM card in the tray. Make sure the ICs is in contact with the socket. The angled corner of the SIM ensures that the card fits only the correct way in the tray.
- 4. Close and lock the tray. You should feel a click when the SIM card is locked securely in the socket.



#### **Installing the Hard Disk**

The system can accommodate one Serial-ATA 2.5" disk. Follow these steps to install a hard disk into the AOPS-7080):

- 1. Take out the hard disk tray from the system.
- 2. Place hard disk on the hard disk tray and align the holes of the hard disk with the mounting holes on the tray.
- 3. Fix the hard disk on the hard disk tray by using 2 mounting screws
- 4. Push the hard disk into the hard disk slot and secure it with a screw.







#### Note:

The system only accommodates 2.5" SSD. It supports SATA 3.0 specification.

## Appendix A: Terms and Conditions

#### **Warranty Policy**

- 1. All products are under warranty against defects in materials and workmanship for a period of one year from the date of purchase.
- 1. Compensation standard of our products in accordance with the Ministry of Finance Notice legitimate consumer damage will be compensated.

#### **Product Warranty**

Product :	Model :	Purchase a day :	year	month	day
Customer Name :	Phone :	Address :			
Mutual agency :	Phone :	Address :			

- When requesting repairs and the year of purchase date must be presented above Enough to receive service so please keep it.
- Major parts of the retention period is 2 years.
- 1. Warranty for this product to ensure the information contained in the warranty benefits.
- 2. The warranty period calculated from the date of purchase dated, so please come (Date of purchase. If this should not check 6 months from date of manufacture from the date of the warranty period shall be added to.)
- 3. Not household products also(operating activities, unusual environments, etc.), or industrial products. If the warranty period of 6 months will apply. (Key parts)
- 4. This warranty will not be reissued.

#### Compensation for consumers guide

Type of consumer harm			Details of compensation		
			Warranty information	After the warranty period	
occurred in normal use performance,	when within 10 days of purchase repair important requiring		Product exchange or The purchase price Refunds		
	when within 1 month of purchase repair important requiring		Product exchange		
	When exchange goods within 1 month of purchase repair important requiring		The purchase price		
	When the exchange is not possible		Refunds		
functional	Miles Alexandria	When Defective goods occurrence	Free fix	Charged repair	
(Components within	When the re fair is possible	Repair for the same Defective, but when recurrence of failures (4 time)	Product exchange		
the retention period	When the repair is not possible		or The purchase price Refunds	Duration of use based on the Depreciation	
	Do not have the repair parts and repair is not possible				
	if consumer requesting repairs products, business lost it				
	At the time of purchase, transport process and product damage incurred during installation		Product exchange		
Due to negligence on the part of consumers performance, failure of functional		Failure due to use of power over			
	When the refair is possible	Connection failures due to equipment failure	Charged repair	Charged repair	
		Failure or defect caused by natural disasters			
	When the refair is not possible	Performance, functional failure or damage is not a defect in	After collecting the amount paid to repair the exchange of goods	Our standard Subject to determined a separate	
Consumer spontaneous decomposition	When the refair is not possible	Trail the decomposition of the consumer if the product	Can not be repaired	Can not be repaired	

• With regard to the product of the three defects in the compensation is not subject.

